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CMOS Digital Integrated Circuits Silicon Monolithic

# 74HC574D

#### 1. Functional Description

Octal D-Type Flip Flop with 3-State Outputs

#### 2. General

The 74HC574D is a high speed CMOS OCTAL FLIP-FLOP with 3-STATE OUTPUT fabricated with silicon gate  $C^2MOS$  technology.

It achieves the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

These 8-bit D-type flip-flops are controlled by a clock input (CK) and an output enable input ( $\overline{\text{OE}}$ ).

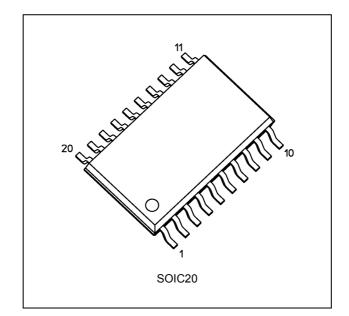
When the  $\overline{\text{OE}}$  input is high, the eight outputs are in a high impedance state.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

#### 3. Features

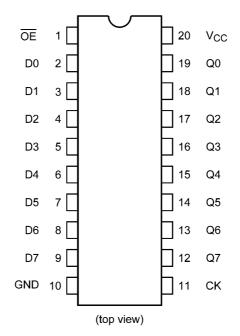
- (1) High speed:  $f_{MAX} = 59$  MHz (typ.) at  $V_{CC} = 6.0$  V
- (2) Low power dissipation:  $I_{CC}$  = 4.0  $\mu$ A (max) at  $T_a$  = 25 °C
- (3) Balanced propagation delays:  $t_{PLH} \approx t_{PHL}$
- (4) Wide operating voltage range:  $V_{CC(opr)} = 2.0 \text{ V to } 6.0 \text{ V}$

#### 4. Packaging

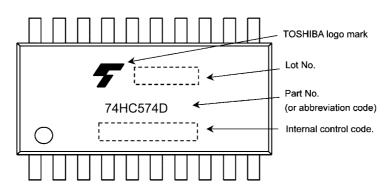


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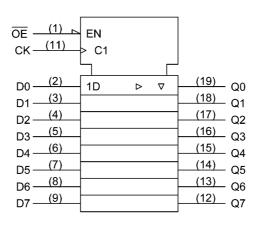
#### 5. Pin Assignment



#### 6. Marking



7. IEC Logic Symbol



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#### 8. Truth Table

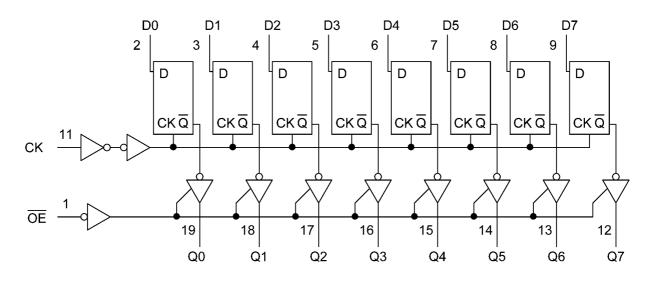
	Inputs		Output
ŌĒ	СК	D	Output
н	Х	Х	Z
L		Х	Qn
L		L	L
L		н	н

X: Don't care

Z: High impedance

Qn: No change

#### 9. System Diagram



#### 10. Absolute Maximum Ratings (Note)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V <sub>CC</sub>		-0.5 to 7.0	V
Input voltage	V <sub>IN</sub>		-0.5 to V <sub>CC</sub> + 0.5	V
Output voltage	V <sub>OUT</sub>		-0.5 to V <sub>CC</sub> + 0.5	V
Input diode current	I <sub>IK</sub>		±20	mA
Output diode current	I <sub>OK</sub>		±20	mA
Output current	I <sub>OUT</sub>		±35	mA
V <sub>CC</sub> /ground current	I <sub>CC</sub>		±75	mA
Power dissipation	PD		500	mW
Storage temperature	T <sub>stg</sub>		-65 to 150	C°

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

#### 11. Operating Ranges (Note)

Characteristics	Symbol	Test Condition	Rating	Unit
Supply voltage	V <sub>CC</sub>		2.0 to 6.0	V
Input voltage	V <sub>IN</sub>		0 to V <sub>CC</sub>	V
Output voltage	V <sub>OUT</sub>		0 to V <sub>CC</sub>	V
Operating temperature	T <sub>opr</sub>		-40 to 85	°C
Input rise and fall times	t <sub>r</sub> ,t <sub>f</sub>	V <sub>CC</sub> = 2.0 V	0 to 1000	ns
		V <sub>CC</sub> = 4.5 V	0 to 500	
		V <sub>CC</sub> = 6.0 V	0 to 400	

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either  $V_{CC}$  or GND.

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#### 12. Electrical Characteristics

### 12.1. DC Characteristics (Unless otherwise specified, $T_a = 25 \text{ °C}$ )

Characteristics	Symbol	Test Conditior	ı	V <sub>CC</sub> (V)	Min	Тур.	Max	Unit
High-level input voltage	V <sub>IH</sub>	—		2.0	1.50	_	_	V
				4.5	3.15	_	_	]
				6.0	4.20	_	_	
Low-level input voltage	VIL	—		2.0	—	—	0.50	<ul> <li></li> </ul>
				4.5	—	—	1.35	
				6.0	—	—	1.80	
High-level output voltage	V <sub>OH</sub>	$V_{IN} = V_{IH} \text{ or } V_{IL}$	I <sub>OH</sub> = -20 μA	2.0	1.9	2.0		>
				4.5	4.4	4.5		
				6.0	5.9	6.0		
			I <sub>OH</sub> = -6 mA	4.5	4.18	4.31		
			I <sub>OH</sub> = -7.8 mA	6.0	5.68	5.80		
Low-level output voltage	V <sub>OL</sub>	$V_{IN} = V_{IH} \text{ or } V_{IL}$	I <sub>OL</sub> = 20 μA	2.0	—	0.0	0.1	<ul> <li></li> </ul>
				4.5	_	0.0	0.1	
				6.0	_	0.0	0.1	
			I <sub>OL</sub> = 6 mA	4.5	_	0.17	0.26	
			I <sub>OL</sub> = 7.8 mA	6.0	_	0.18	0.26	
3-state output OFF-state leakage current	I <sub>OZ</sub>	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = V_{CC} \text{ or } GND$		6.0	_	—	±0.5	μA
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		6.0	—	_	±0.1	μA
Quiescent supply current	I <sub>CC</sub>	$V_{IN} = V_{CC}$ or GND		6.0			4.0	μA

#### 12.2. DC Characteristics (Unless otherwise specified, $T_a = -40$ to 85 °C)

Characteristics	Symbol	Test Conditior	ı	V <sub>CC</sub> (V)	Min	Max	Unit
High-level input voltage	VIH	—		2.0	1.50	—	V
				4.5	3.15	_	
				6.0	4.20	—	
Low-level input voltage	VIL	_		2.0	_	0.50	V
				4.5	_	1.35	
				6.0	_	1.80	
High-level output voltage	V <sub>OH</sub>	$V_{IN} = V_{IH} \text{ or } V_{IL}$	I <sub>OH</sub> = -20 μA	2.0	1.9	_	V
				4.5	4.4	_	
				6.0	5.9	_	
			I <sub>OH</sub> = -6 mA	4.5	4.13	_	]
			I <sub>OH</sub> = -7.8 mA	6.0	5.63	_	
Low-level output voltage	V <sub>OL</sub>	$V_{IN} = V_{IH} \text{ or } V_{IL}$	I <sub>OL</sub> = 20 μA	2.0	_	0.1	V
				4.5	_	0.1	
				6.0	_	0.1	
			I <sub>OL</sub> = 6 mA	4.5	_	0.33	
			I <sub>OL</sub> = 7.8 mA	6.0	_	0.33	
3-state output OFF-state leakage current	I <sub>OZ</sub>	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = V_{CC} \text{ or } GND$		6.0	_	±5.0	μΑ
Input leakage current	I <sub>IN</sub>	$V_{IN} = V_{CC}$ or GND		6.0	_	±1.0	μA
Quiescent supply current	I <sub>CC</sub>	$V_{IN} = V_{CC}$ or GND		6.0		40.0	μA

#### 12.3. Timing Requirements (Unless otherwise specified, $T_a = 25$ °C, Input: $t_r = t_f = 6$ ns)

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Тур.	Limit	Unit
Minimum pulse width	$t_{w(L)}, t_{w(H)}$	_	2.0	_	75	ns
(CK)			4.5	_	15	
			6.0	_	13	
Minimum setup time	ts	_	2.0	_	75	ns
(Dn)			4.5	—	15	
			6.0	_	13	
Minimum hold time	t <sub>h</sub>	_	2.0	_	0	ns
(Dn)			4.5	—	0	
			6.0	_	0	
Clock frequency	f	—	2.0	—	6	MHz
			4.5	_	31	
			6.0	_	36	

# 12.4. Timing Requirements (Unless otherwise specified, $T_a = -40$ to 85 °C, Input: $t_r = t_f = 6$ ns)

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Limit	Unit
Minimum pulse width	$t_{w(L)}, t_{w(H)}$	—	2.0	95	ns
(CK)			4.5	19	
			6.0	16	
Minimum setup time	ts	—	2.0	95	ns
(Dn)			4.5	19	
			6.0	16	
Minimum hold time	t <sub>h</sub>	—	2.0	0	ns
(Dn)			4.5	0	
			6.0	0	
Clock frequency	f	_	2.0	5	MHz
			4.5	24	
			6.0	28	

#### 12.5. AC Characteristics (Unless otherwise specified, $T_a = 25$ °C, Input: $t_r = t_f = 6$ ns)

Characteristics	Symbol	Note	Test Condition	C <sub>L</sub> (pF)	V <sub>CC</sub> (V)	Min	Тур.	Max	Unit
Output transition time	t <sub>TLH</sub> ,t <sub>THL</sub>		_	50	2.0	_	25	60	ns
					4.5	_	7	12	
					6.0	_	6	10	
Propagation delay time	t <sub>PLH</sub> ,t <sub>PHL</sub>		_	50	2.0	_	70	150	ns
(CK-Q)					4.5	_	20	30	
					6.0	_	15	26	
				150	2.0	_	88	190	
					4.5	_	25	38	
					6.0	_	19	33	
Output enable time	t <sub>PZL</sub> ,t <sub>PZH</sub>		R <sub>L</sub> = 1 kΩ	50	2.0	_	48	125	ns
					4.5	_	15	25	
					6.0	_	12	21	
				150	2.0	_	60	165	
					4.5	_	20	33	
					6.0	_	16	28	
Output disable time	t <sub>PLZ</sub> ,t <sub>PHZ</sub>		R <sub>L</sub> = 1 kΩ	50	2.0	_	34	125	ns
					4.5	_	17	25	
					6.0	_	15	21	
Maximum clock frequency	f <sub>MAX</sub>		_	50	2.0	6	17	_	MHz
					4.5	31	50	_	
					6.0	36	59	_	
Input capacitance	C <sub>IN</sub>		_			_	5	10	pF
Output capacitance	C <sub>OUT</sub>		_			_	10	_	pF
Power dissipation capacitance	C <sub>PD</sub>	(Note 1)	_			_	54	_	pF

Note 1: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation.

 $I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{IN} + I_{CC}/8 \text{ (per latch)}$ 

And the total  $C_{PD}$  when n pcs of latch operate can be gained by the following equation.

 $C_{PD}$  (total) = 39 + 15 × n

# 12.6. AC Characteristics (Unless otherwise specified, $T_a$ = -40 to 85 °C, Input: $t_r$ = $t_f$ = 6 ns)

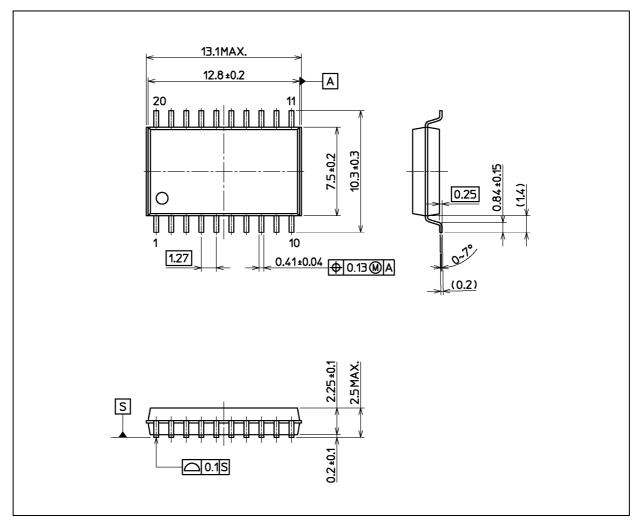
Characteristics	Symbol	Test Condition	C <sub>L</sub> (pF)	V <sub>CC</sub> (V)	Min	Max	Unit
Output transition time	t <sub>TLH</sub> ,t <sub>THL</sub>	_	50	2.0	—	75	ns
				4.5	_	15	
				6.0	_	13	1
Propagation delay time	t <sub>PLH</sub> ,t <sub>PHL</sub>	_	50	2.0	_	190	ns
(CK-Q)				4.5	_	38	]
				6.0	_	33	1
			150	2.0	_	240	]
				4.5	_	48	]
				6.0	_	41	1
Output enable time	t <sub>PZL</sub> ,t <sub>PZH</sub>	R <sub>L</sub> = 1 kΩ	50	2.0	_	155	ns
				4.5	_	31	
				6.0	_	26	1
			150	2.0	_	205	]
				4.5	_	41	1
				6.0	_	35	]
Output disable time	t <sub>PLZ</sub> ,t <sub>PHZ</sub>	R <sub>L</sub> = 1 kΩ	50	2.0	_	155	ns
				4.5	_	31	]
				6.0	_	26	]
Maximum clock frequency	f <sub>MAX</sub>	_	50	2.0	5	_	MHz
				4.5	24	_	]
				6.0	28	_	
Input capacitance	C <sub>IN</sub>	_			_	10	pF



#### **Package Dimensions**

74HC574D

Unit: mm



Weight: 0.51 g (typ.)

Package Name(s)

Nickname: SOIC20

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